281695-6 - ACTIVE

AMPMODU | AMPMODU HE 13/HE 14

TE Internal #: 281695-6 PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14

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Connectors > PCB Connectors > PCB Headers & Receptacles > HE13/HE14 TH Headers, SRST



Connector System: Wire-to-Board

Number of Positions: 6

Number of Rows: 1

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Orientation: Vertical

All HE13/HE14 TH Headers, SRST (21)



Features

Product Type Features

Connector System	Wire-to-Board	
Header Type	Partially Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
Number of Positions	6	
Number of Rows	1	
PCB Mount Orientation	Vertical	
Electrical Characteristics		
Insulation Resistance	1000 MΩ	

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Body Features	
Primary Product Color	Blue
Contact Features	
Contact Mating Area Length	7 mm
Mating Square Post Dimension	.64 mm[.025 in]
Contact Mating Area Plating Material Thickness	.8 µm[31 µin]
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.63 mm[.025 in]
Termination Post & Tail Length	2.9 mm
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	With
Panel Mount Feature	Without
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Retention	Without
Housing Features	
Housing Material	High Temperature Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Usage Conditions	
Operating Temperature Range	-40 – 100 °C[-40 – 212 °F]

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Circuit Application	Signal	
ndustry Standards		
Compatible With Approved Standards Products	CSA LR7189, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	4000	
Packaging Type	Box	
EU RoHS Directive 2011/65/EU	Compliant	
EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC	Compliant Compliant	
	·	
EU ELV Directive 2000/53/EC	Compliant	

ppm.

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

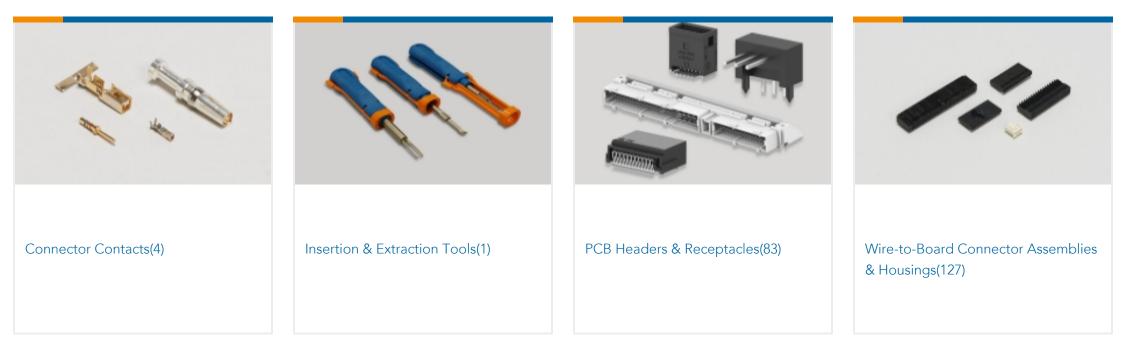
Compatible Parts

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14





Also in the Series AMPMODU HE 13/HE 14



Customers Also Bought



	= TE	= TE	
TE Part #281739-3 HE13/HE14 TH Headers, DRST	TE Part #281695-8 HE13/HE14 TH Headers, SRST	TE Part #2319764-3 E STACK PIANO 6P G LONG TUBE PD ON	TE Part #281786-6 PLUG HE14 IDC 180 6 P AWG 28-26



Documents

Product Drawings HEADER HE14 STRAIGHT 6 P

English

CAD Files

Customer View Model

ENG_CVM_CVM_281695-6_G.2d_dxf.zip

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14



English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_281695-6_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_281695-6_G.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications
Product Specification

French